Vishay Semiconductors

High Speed Infrared Emitting Diodes, 850 nm, Surface Emitter Technology



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LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

As part of the <u>SurfLightTM</u> portfolio, the VSMY2853 series are infrared, 850 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

FEATURES

- Package type: surface-mount
- Package form: GW, RGW
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55
- Peak wavelength: $\lambda_p = 850 \text{ nm}$
- High reliability
- · High radiant power
- · Very high radiant intensity
- Angle of half intensity: $\varphi = \pm 28^{\circ}$
- · Suitable for high pulse current operation
- Terminal configurations: gullwing or reverse gullwing
- Package matches with detector VEMD2503X01 series
- Floor life: 4 weeks, MSL 2a, according to J-STD-020
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Miniature light barrier
- Photointerrupters
- · Optical switch
- Emitter source for proximity sensors
- IR touch panels
- IR illumination
- Smart metering

PRODUCT SUMMARY				
COMPONENT	I _e (mW/sr)	φ (°)	λ _p (nm)	t _r (ns)
VSMY2853RG	50	± 28	850	10
VSMY2853G	50	± 28	850	10

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VSMY2853RG	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing		
VSMY2853G	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing		

Note

• MOQ: minimum order quantity



HALOGEN FREE GREEN (5-2008)



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ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		۱ _F	100	mA	
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	200	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1	A	
Power dissipation		Pv	190	mW	
Junction temperature		Tj	100	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-40 to +100	°C	
Soldering temperature	According to Fig. 7, J-STD-020	T _{sd}	260	°C	
Thermal resistance junction to ambient	EIA / JESD51	R _{thJA}	250	K/W	

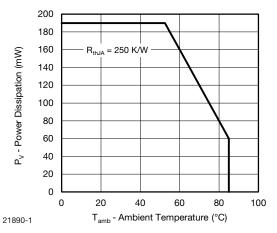


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

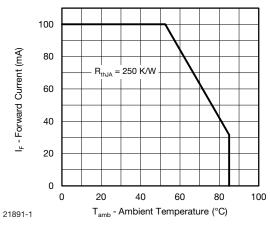


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V _F	-	1.6	1.9	V
	I _F = 1 A, t _p = 100 μs	V _F	-	2.8	-	V
Temperature coefficient of V _F	I _F = 100 mA	TK _{VF}	-	-1.5	-	mV/K
Reverse current		I _R	Not designed for reverse operation			μA
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CJ	-	50	-	pF
Radiant intensity	I _F = 100 mA, t _p = 20 ms	l _e	27	50	75	mW/sr
	I _F = 1 A, t _p = 100 μs	l _e	-	350	-	mW/sr
Radiant power	I _F = 100 mA, t _p = 20 ms	фе	-	55	-	mW
Temperature coefficient of radiant power	I _F = 100 mA	ΤΚφ _e	-	-0.12	-	%/K
Angle of half intensity		φ	-	± 28	-	0
Peak wavelength	l _F = 100 mA	λ _p	840	850	870	nm
Spectral bandwidth	I _F = 30 mA	Δλ	-	30	-	nm
Temperature coefficient of λ_p	I _F = 30 mA	ΤΚλ _ρ	-	0.25	-	nm/K
Rise time	I _F = 100 mA, 10 % to 90 %	t _r	-	10	-	ns
Fall time	I _F = 100 mA, 10 % to 90 %	t _f	-	10	-	ns

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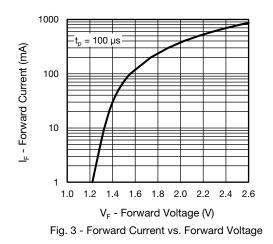
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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



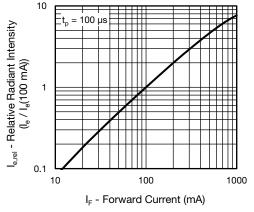
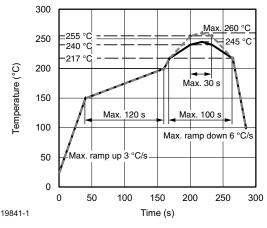
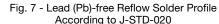


Fig. 4 - Relative Radiant Intensity vs. Forward Current

SOLDER PROFILE





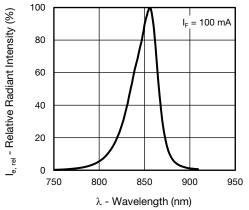
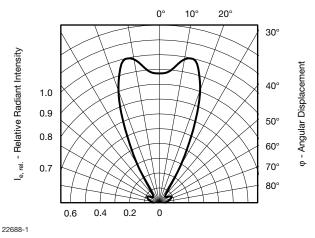


Fig. 5 - Relative Radiant Power vs. Wavelength





DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 2a, according to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

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3 estions contact: SensorsTechSuppor

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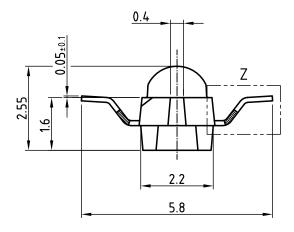


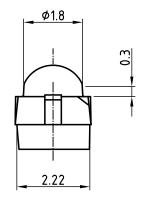


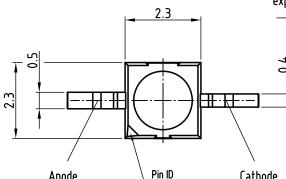
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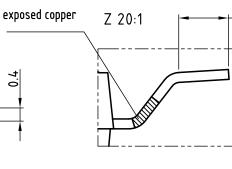
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PACKAGE DIMENSIONS in millimeters: VSMY2853RG





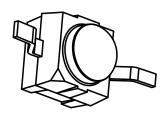




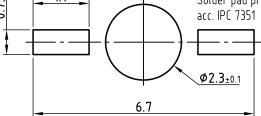


technical drawings according to DIN specifications

Dimensions in mm Not indicated tolerances ±0.2



C Pin ID Anode Cathode 1.7 0.75 Solder pad proposal



Drawing refers to following types:

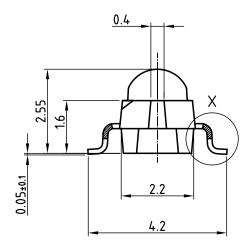
VSMY2853RG

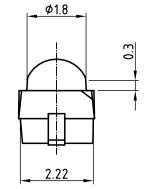
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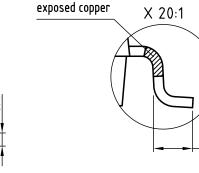


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PACKAGE DIMENSIONS in millimeters: VSMY2853G



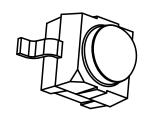


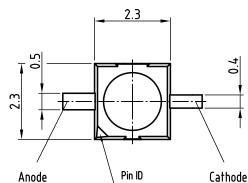


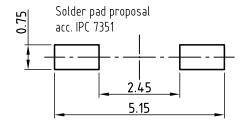


0.6

Dimensions in mm Not indicated tolerances ±0.2



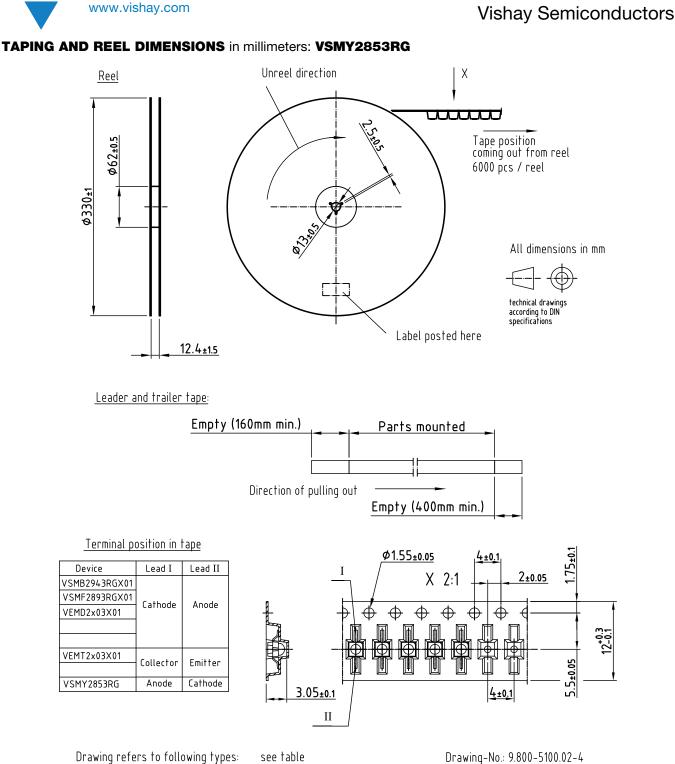




Drawing refers to following types:

VSMY2853G

Drawing-No.: 6.544-5408.03-4 Issue: prel; 03.08.12



Issue: prel; 03.08.12

VSMY2853RG, VSMY2853G

Reel dimensions and tape

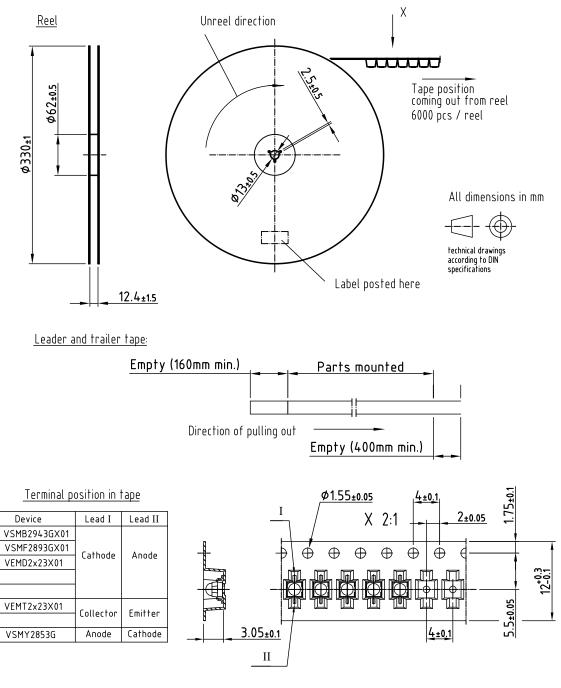
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TAPING AND REEL DIMENSIONS in millimeters: VSMY2853G



Drawing refers to following types: see table Reel dimensions and tape Drawing-No.: 9.800-5091.21-4 Issue: prel; 03.08.12

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